PRODUCT BRIEF
Intel® Desktop Board D2700MUD
Innovation Series



Mini-ITX Form Factor

Intel® Desktop Board D2700MUD Innovation Series





The Intel® Desktop Board D2700MUD is the latest Innovation Series board that optimizes the performance of the Intel® Atom™ processor D2700 and the Intel® NM10 Express Chipset by delivering new-generation technologies, value-added features, and easy integration. The Intel Desktop Board D2700MUD is suitable for Internet-based computing that requires dual independent display capabilities.

The Intel Desktop Board D2700MUD features the new integrated dual-core 2.13 GHz Intel Atom processor D2700. This processor supports Intel® Graphics Media Accelerator 3650, an improved graphics core that supports high-definition video playback capabilities compared with the previous-generation entry-level desktop PC.

This board provides flexibility and upgradability with two single-channel SODIMM connectors for DDR3 1066 / 800 MHz memory support (4 GB¹ max). The use of SODIMM memory modules delivers greater performance and power efficiency. The revolutionary two-chip layout continues to enable lower power consumption and saves 70 percent of its board layout size. This results in a board that has better heat flow with the passive thermal solution.

The Intel Desktop Board D2700MUD provides enhanced features such as 10/100/1000 Mb/s integrated LAN, integrated six-channel Intel® High Definition Audio®, display capability with VGA and digital DVI ports. Supporting a USB Solid-State Drive keep-out zone design, the

Intel Desktop Board D2700MUD is ideal for diskless usage model by integrating the USB Solid-State Drive inside the chassis.

The Intel Desktop Board D2700MUD is a mini-ITX form factor board. Backward-compatible with ATX and microATX, this form factor allows you to build green, energy-efficient, small form factor solutions. This board offers simple, affordable, Internet-centric computer designs in a compact 170mm x 170mm size—perfect for a cool system with a small form factor chassis.

Available at an affordable price, the Intel Desktop Board D2700MUD is ideal for innovative small form factor systems.



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The boxed Intel® Desktop Board D2700MUD solution includes:

- ATX 2.2 compliant I/O shield
- ■SATA cables
- Board and back panel I/O layout stickers
- Quick reference guide
- •Intel® Express Installer driver and software DVD
- Microsoft* Windows* 7 WHQL certified

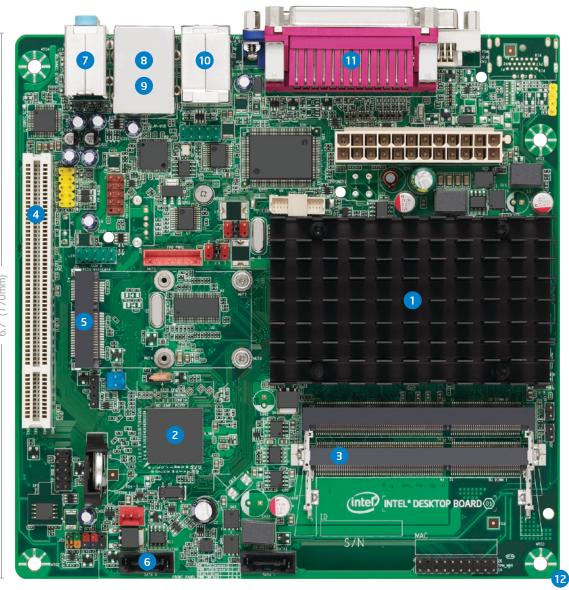
The takeaway software included with the Intel® Desktop Board D2700MUD works best for your everyday computing.

CAPABILITY	SOFTWARE INCLUDED:
Productivity	■Intel AppUp SM
	■Intel® Integrator Assistant (Internet Download)
	■ Laplink* PCmover Express*
Entertainment	■ DivX* for Windows*
Antivirus	■ ESET* Smart Security 4 (45-day license)

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Features and Benefits

- Integrated with the new dual-core Intel® Atom™ processor D2700: Features an integrated graphics core (Intel® GMA 3650) with high-definition graphics performance improvements.
- 2 Intel® NM10 Express Chipset: Designed to support the new Intel® Atom™ processor D2700.
- 3 Single-channel DDR3 with two connectors for 1066 / 800 MHz memory support (4 GB¹ max)
- 4 One PCI connector: Expansion connector for custom system configurations and future add-in card upgrades.
- 5 One PCI Express* Mini Card connector: Expansion connector for future add-in upgrades such as Wi-Fi* or WiMax* cards.
- 6 Two SATA ports (3.0 Gb/s)
- Six-channel Intel® High Definition Audio²: Rich integrated stereo audio experience.
- 8 Integrated 10/100/1000 Mb/s Network Connection
- 9 Seven Hi-Speed USB 2.0 ports: Four back panel ports and three additional ports via internal header.
- 10 PS/2 port: Supports keyboard or mouse.
- 11 Parallel and serial ports: Provide legacy device compatibility.
- 12 Mini-ITX / microATX-compatible form factor



6.7" (170mm)

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Technical Specifications

For ordering information, visit www.intel.com

For the most current product information, visit http://developer.intel.com/products/desktop/motherboard/

PROCESSOR

Processor Support

 Intel® Atom™ processor D2700 (dual-core / 2.13 GHz / Intel® Hyper-Threading Technology3 / 512 KB x 2 L2 cache)

CHIPSET

Intel® NM10 Express Chipset

Graphics

- Intel® Graphics Media Accelerator 3650
- One VGA port
- One digital DVI port

I/O Controller

- Two SATA ports (fully shrouded)
- One PS/2 port
- Two serial headers
- One parallel port

USB 2.0

- Four external ports
- Three ports via headers

Audio Solution

- 5.1 channel Intel® High Definition Audio² (with multi-streaming)
- Front-panel mic / headphone header

10/100/1000 Network Connection

 Intel[®] 82574L 10/100/1000 Mb/s Ethernet Controller

System BIOS

- 8 Mb Flash FEPROM with Intel® Platform Innovation. Framework for EFI Plug and Play, IDE drive autoconfigure
- Advanced configuration and power interface V2.0b, DMI 2.0, multilingual support
- Serial Peripheral Interface (SPI) Flash

Fast Boot BIOS

 Optimized POST for almost instant-on access to PC from power-on

SYSTEM MEMORY

Memory Capacity

 Single-channel DDR3 with two connectors for 1066 / 800 MHz memory support (4 GB¹ max)

Memory Types

- DDR3 1066 / 800 SDRAM memory support
- Non-ECC Memory

Memory Voltage

1.8 V

Wake-up from Network

- Wired for Management (WfM) 2.0 compatible
- Support for system wake-up using an add-in network interface card with remote wake-up capability

Expansion Capabilities

- One PCI connector
- One PCI Express* Mini Card connector

IUMPERS AND FRONT PANEL CONNECTORS lumpers

- Jumper: yellow
- Header: black

Front-Panel Connectors

- Reset, HD LED, Power LEDs, power on/off, aux LED
- USB 2.0 headers
- Audio header

MECHANICAL

Board Style

- Mini-ITX / microATX-compatible
- 170mm x 170mm

Baseboard Power Requirements

ATX12V or SFX12V

ENVIRONMENT

Operating Temperature

• 0°C to +50°C

Storage Temperature

-20°C to +70°C

REGULATIONS AND SAFETY STANDARDS

United States and Canada

UL 60950-1

Canada

CAN / CSA-C22.2 No. 60950-1

Europe

(Low Voltage Directive 2006/95/EC) FN 60950-1

International

IFC 60950-1

EMC Regulations (Class B)

United States

FCC CFR Title 47, Chapter I, Part 15, Subparts A / B

Canada

ICFS-003

Europe

(EMC Directive 2004/108/EC) EN 55022 and EN 55024

Australia/New Zealand

EN 55022

Japan

VCCI V-3, V-4

South Korea

KN-22 and KN-24

Taiwan

CNS 13438

International

CISPR 22

Environmental Compliance

Europe RoHS (Directive 2002/95/EC)

China

China RoHS (MII Order # 39)

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Actual Intel® Desktop Board may differ from the image shown.

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¹ System resources and hardware (such as PCI and PCI Express*) require physical memory address locations that can reduce available addressable system memory. This could result in a reduction of as much as 1 GB or more of physical addressable memory being available to the operating system and applications, depending on the system configuration and operating system.

² Intel® High Definition Audio requires a system with an appropriate Intel® chipset and a motherboard with an appropriate codec and the necessary drivers installed. System sound quality will vary depending on actual implementation, controller, codec, drivers, and speakers. For more information about Intel® HD Audio, refer to www.intel.com/design/chipsets/hdaudio.htm

³ Intel® Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS, and operating system. Performance will vary depending on the specific hardware and software you use. For more information including details on which processors support HT Technology, see www.intel.com/info/hyperthreading.

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